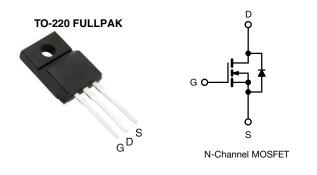
Vishay Siliconix



Power MOSFET



PRODUCT SUMMA	RY	
V _{DS} (V)	900)
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	3.7
Q _g max. (nC)	78	
Q _{gs} (nC)	10	
Q _{gd} (nC)	42	
Configuration	Sing	le

FEATURES

- Isolated package
- High voltage isolation = 2.5 kV_{RMS} (t = 60 s; f = 60 Hz)
- Sink to lead creepage distance = 4.8 mm
- Dynamic dV/dt rating
- Low thermal resistance
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

DESCRIPTION

Third generation power MOSFETs from Vishay provides the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	IRFIBF30GPbF

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	900	N/	
Gate-source voltage			V _{GS}	± 20	- V	
Continuous drain current	V _{GS} at 10 V	T _C = 25 °C	1	1.9		
Continuous drain current	V _{GS} at 10 V	T _C = 100 °C	ID	1.2	А	
Pulsed drain current ^a			I _{DM}	7.6		
Linear derating factor				0.28	W/°C	
Single pulse avalanche energy ^b			E _{AS}	220	mJ	
Repetitive avalanche current ^a			I _{AR}	1.9	А	
Repetitive avalanche energy ^a			E _{AR}	3.5	mJ	
Maximum power dissipation	T _C =	25 °C	PD	35	W	
Peak diode recovery dV/dt ^c			dV/dt	1.5	V/ns	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150		
Soldering recommendations (peak temperature) ^d	For	10 s	-	300	- °C	
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting torque	0-32 Or I	VIS SCREW		1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 115 mH, $R_q = 25 \Omega$, $I_{AS} = 1.9$ A (see fig. 12)

c.
$$I_{SD} \leq 3.6$$
 A, dI/dt ≤ 70 A/µs, $V_{DD} \leq 600, \, T_J \leq 150 \ ^\circ C$

d. 1.6 mm from case

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1 For technical questions, contact: <u>hvm@vishay.com</u>

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THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	ТҮР	-	MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	- 65			°C 111			
Maximum junction-to-case (drain)	R _{thJC}	- 3.6				°C/W		
	•		•			•		
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	unless otherw	ise noted)						
PARAMETER	SYMBOL	TES	T CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static		•			•		•	
Drain-ssource breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	50 µA	900	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	1.1	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 μA	2.0	-	4.0	V
Gate-source leakage	I _{GSS}		V _{GS} = ± 20 V	V	-	-	± 100	nA
		V _{DS} =	= 900 V, V _{GS}	s = 0 V	-	-	100	μA
Zero gate voltage drain current	IDSS	V _{DS} = 720 V	/, V _{GS} = 0 V,	, T _J = 125 °C	-	-	500	
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D :	= 1.1 A ^b	-	-	3.7	Ω
Forward transconductance	9 _{fs}		= 50 V, I _D = ⁻	1.1 A ^b	1.7	-	-	S
Dynamic							•	
Input capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1.0 MHz, see fig. 5		-	1200	-	pF	
Output capacitance	C _{oss}			-	320	-		
Reverse transfer capacitance	C _{rss}			-	200	-		
Drain to sink capacitance	С		f = 1.0 MHz	2	-	12	-	
Total gate charge	Qg				-	-	78	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 V$ $I_D = 3.6 A, V_D$		-	-	10	nC
Gate-drain charge	Q _{gd}		See lig	J. 6 and 13 ^b	-	-	42	
Turn-on delay time	t _{d(on)}		•		-	14	-	
Rise time	t _r	V _{DD} = 450 V, I _D = 3.6 A, R _g = 12 Ω, R _D = 120 Ω, see fig. 10 ^b		-	25	-	- ns	
Turn-off delay time	t _{d(off)}			-	90	-		
Fall time	t _f		eee ngi re		-	30	-	1
Gate input resistance	R _g	f = 1	MHz, open	drain	0.4	-	2.0	Ω
Internal drain inductance	L _D	Between 6 mm (0.25	") from		-	4.5	-	
Internal source inductance	Ls	package and center of die contact		-	7.5	-	nH	
Drain-Source Body Diode Characteristi	cs							
Continuous source-drain diode current	١ _S	showing the	MOSFET symbol showing the		-	-	1.9	^
Pulsed diode forward current ^a	I _{SM}	p - n junction diode		-	-	7.6	A	
Body diode voltage	V _{SD}	T _J = 25 °C	, I _S = 1.9 A,	$V_{GS} = 0 V^{b}$	-	-	1.8	V
Body diode reverse recovery time	t _{rr}				-	430	650	ns
Body diode reverse recovery charge	Q _{rr}	$T_J = 25 \text{ °C}, I_F = 3.6 \text{ A}, dI/dt = 100 \text{ A}/\mu \text{s}^{\text{ b}}$		-	1.4	2.1	μC	
Forward turn-on time	t _{on}	Intrinsic tu	ırn-on time i	is negligible (turn	-on is dor	minated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 $\,\%$

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

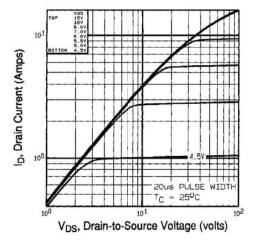


Fig. 1 - Typical Output Characteristics, $T_C = 25 \ ^{\circ}C$

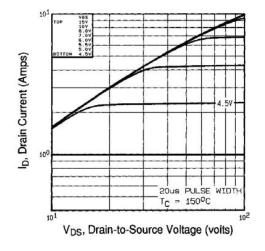


Fig. 2 - Typical Output Characteristics, T_C = 150 °C

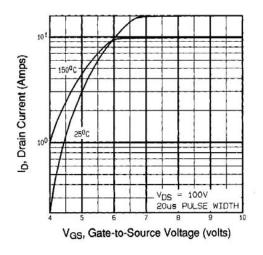


Fig. 3 - Typical Transfer Characteristics

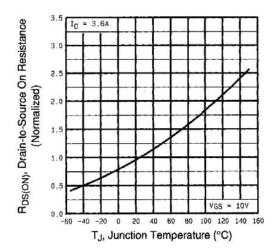


Fig. 4 - Normalized On-Resistance vs. Temperature



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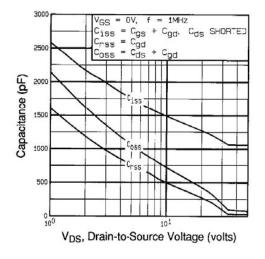


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

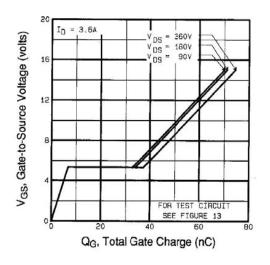


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

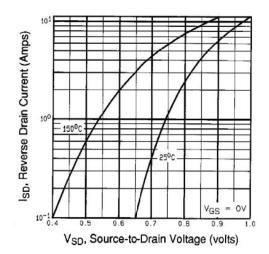


Fig. 7 - Typical Source-Drain Diode Forward Voltage

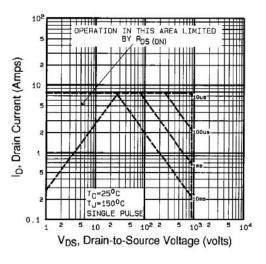


Fig. 8 - Maximum Safe Operating Area

4



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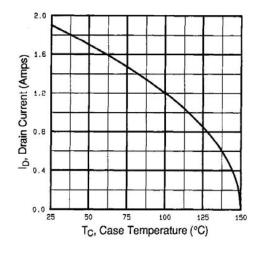


Fig. 9 - Maximum Drain Current vs. Case Temperature

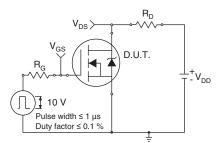


Fig. 10a - Switching Time Test Circuit

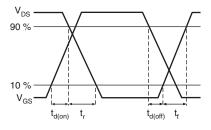


Fig. 10b - Switching Time Waveforms

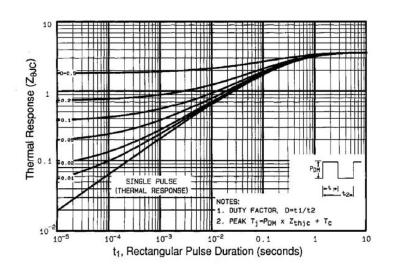


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

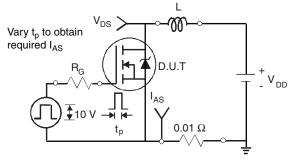


Fig. 12a - Unclamped Inductive Test Circuit

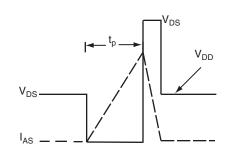
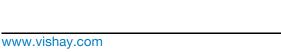


Fig. 12b - Unclamped Inductive Waveforms

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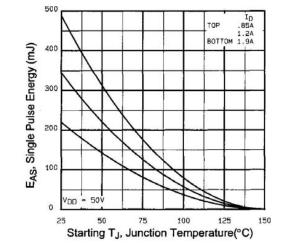


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

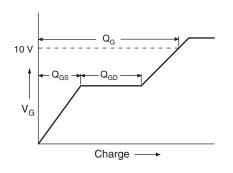


Fig. 13a - Basic Gate Charge Waveform

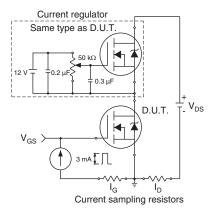
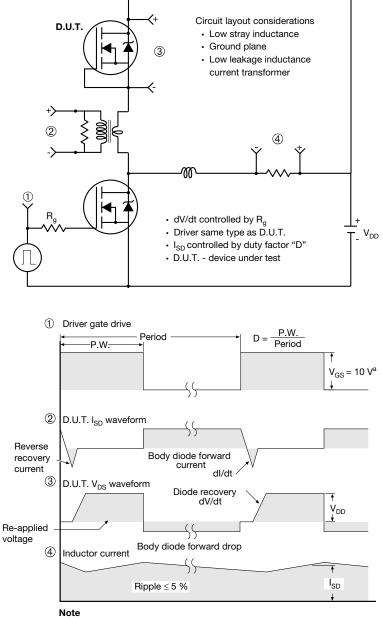


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9



		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
A	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
 6. Facility code will be the 1st character located at the 2nd row of the unit marking

1



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OPTION 2: FACILITY CODE = Y



MILLIMETERS		IETERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.570	4.830	0.180	0.190
A1	2.570	2.830	0.101	0.111
A2	2.510	2.850	0.099	0.112
b	0.622	0.890	0.024	0.035
b2	1.229	1.400	0.048	0.055
b3	1.229	1.400	0.048	0.055
С	0.440	0.629	0.017	0.025
D	8.650	9.800	0.341	0.386
d1	15.88	16.120	0.622	0.635
d3	12.300	12.920	0.484	0.509
E	10.360	10.630	0.408	0.419
е	2.54	BSC	0.100) BSC
L	13.200	13.730	0.520	0.541
L1	3.100	3.500	0.122	0.138
n	6.050	6.150	0.238	0.242
ØP	3.050	3.450	0.120	0.136
u	2.400	2.500	0.094	0.098
V	0.400	0.500	0.016	0.020

DWG: 5972

Notes

1. To be used only for process drawing

2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads

3. All critical dimensions should C meet $C_{pk} > 1.33$

4. All dimensions include burrs and plating thickness

5. No chipping or package damage
6. Facility code will be the 1st character located at the 2nd row of the unit marking

2

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